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(54) FILTER MODULE WITH ENHANCED TEMPERATURE RUGGEDNESS IN **SMALLER SIZE**

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ABSTRACT (57)

A filter module comprises a first terminal, a second terminal, and a filter disposed along each signal path extending from the first terminal to the second terminal, the filter including a plurality of series resonators and a plurality of shunt resonators disposed between the series resonators and a ground, at least one resonator among the plurality of series resonators and the plurality of shunt resonators being a first type of resonator with a temperature compensating layer for better temperature coefficient of frequency, at least one resonator among the plurality of series resonators and the plurality of shunt resonators being a second type of resonator without a temperature compensating layer.

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